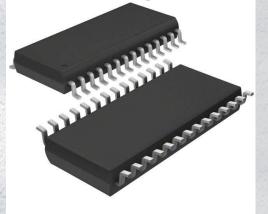


## **TRS3238ECPWR Datasheet**

www.digi-electronics.com



DiGi Electronics Part Number	TRS3238ECPWR-DG
Manufacturer	Texas Instruments
Manufacturer Product Number	TRS3238ECPWR
Description	IC TRANSCEIVER FULL 5/3 28TSSOP
Detailed Description	5/3 Transceiver Full RS232 28-TSSOP

https://www.DiGi-Electronics.com



Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com

DiGi is a global authorized distributor of electronic components.



## Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
TRS3238ECPWR	Texas Instruments
Series:	Product Status:
	Obsolete
Type:	Protocol:
Transceiver	RS232
Number of Drivers/Receivers:	Duplex:
5/3	Full
Receiver Hysteresis:	Data Rate:
300 mV	400kbps
Voltage - Supply:	Operating Temperature:
3V ~ 5.5V	0°C ~ 70°C
Mounting Type:	Package / Case:
Surface Mount	28-TSSOP (0.173", 4.40mm Width)
Supplier Device Package:	Base Product Number:
28-TSSOP	TRS3238

## **Environmental & Export classification**

RoHS Status:	Moisture Sensitivity Level (MSL):
ROHS3 Compliant	1 (Unlimited)
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTSUS:	
8542.39.0001	

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### 3-V TO 5.5-V MULTICHANNEL RS-232 LINE DRIVER/RECEIVER WITH ±15-kV ESD (HBM) PROTECTION SLLS797-JUNE 2007

FEATURES

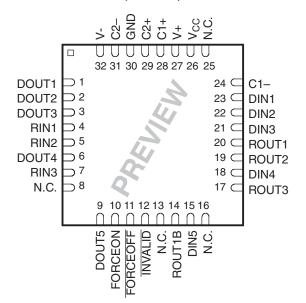
- RS-232 Bus-Pin ESD Protection Exceeds ±15 kV Using Human-Body Model (HBM)
- Meets or Exceeds the Requirements of TIA/EIA-232-F and ITU v.28 Standards
- Operates With 3-V to 5.5-V V<sub>CC</sub> Supply
- Operates up to 400 kbit/s
- Five Drivers and Three Receivers
- Auto-Powerdown Plus Feature Enables Flexible Power-Down Mode
- Low Standby Current . . . 1 µA Typical
- External Capacitors . . . 4  $\times$  0.1  $\mu F$
- Accepts 5-V Logic Input With 3.3-V Supply
- Always-Active Noninverting Receiver Output (ROUT1B)
- Alternative High-Speed Pin-Compatible Device (1 Mbit/s) for TRSF3238
- ESD Protection for RS-232 Interface Pins
  - ±15 kV Human-Body Model (HBM)
  - ±8 kV IEC61000-4-2, Contact Discharge
  - ±15 kV IEC61000-4-2, Air-Gap Discharge

#### **APPLICATIONS**

- Battery-Powered Systems
- PDAs
- Notebooks
- Subnotebooks
- Laptops
- Palmtop PCs
- Hand-Held Equipment
- Modems
- Printers

DB, DW, OR PW PACKAGE (TOP VIEW)								
C2+ GND C2- DOUT1 DOUT2 DOUT3 RIN1 RIN2 DOUT4 RIN3 FORCEON	1 2 3 4 5 6 7 8 9 10 11 12 13		28 27 26 25 24 23 22 21 20 19 18 17 16	C1+ V+ C1- DIN1 DIN2 DIN3 ROUT1 ROUT2 DIN4 ROUT3 DIN5 ROUT1B				
FORCEOFF	14		15					





N.C. - Not inter nally connected

#### **DESCRIPTION/ORDERING INFORMATION**

The TRS3238E consists of five line drivers, three line receivers, and a dual charge-pump circuit with  $\pm$ 15-kV ESD (HBM) protection on the driver output (DOUT) and receiver input (RIN) terminals. The device meets the requirements of TIA/EIA-232-F and provides the electrical interface between notebook and subnotebook computer applications. The charge pump and four small external capacitors allow operation from a single 3-V to 5.5-V supply. In addition, the device includes an always-active noninverting output (ROUT1B), which allows applications using the ring indicator to transmit data while the device is powered down. This device operates at data signaling rates up to 250 kbit/s and a maximum of 30-V/µs driver output slew rate.

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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## TRS3238E 3-V TO 5.5-V MULTICHANNEL RS-232 LINE DRIVER/RECEIVER WITH $\pm 15\text{-kV}$ ESD (HBM) PROTECTION



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#### DESCRIPTION/ORDERING INFORMATION (CONTINUED)

Flexible control options for power management are featured when the serial port and driver inputs are inactive. The auto-powerdown plus feature functions when FORCEON is low and FORCEOFF is high. During this mode of operation, if the device does not sense valid signal transitions on all receiver and driver inputs for approximately 30 s, the built-in charge pump and drivers are powered down, reducing the supply current to 1  $\mu$ A. By disconnecting the serial port or placing the peripheral drivers off, auto-powerdown plus occurs if there is no activity in the logic levels for the driver inputs. Auto-powerdown plus can be disabled when FORCEON and FORCEOFF are high. With auto-powerdown plus enabled, the device activates automatically when a valid signal is applied to any receiver or driver input. INVALID is high (valid data) if any receiver input voltage is greater than 2.7 V or less than -2.7 V, or has been between -0.3 V and 0.3 V for less than 30  $\mu$ s. Refer to Figure 5 for receiver input levels.

T <sub>A</sub>	PA	CKAGE <sup>(1)(2)</sup>	ORDERABLE PART NUMBER	TOP-SIDE MARKING	
	SSOP – DB	Tube of 50	TRS3238ECDB	TDC2220FC	
0°C to 70°C	550P - DB	Reel of 2000	TRS3238ECDBR	- TRS3238EC	
	TSSOP – PW	Tube of 50	TRS3238ECPW	- RS38EC	
	1330F - FW	Reel of 2000	TRS3238ECPWR	ROSOEC	
	SOIC – DW	Reel of 2000	TRS3238ECDWR	TRS3238EC	
	QFN – RHB	Reel of 2000	TRS3238ECRHBR	PREVIEW	
	SSOP – DB	Tube of 50	TRS3238EIDB	TRS3238EI	
	330F - DB	Reel of 2000	TRS3238EIDBR	TROSESI	
–40°C to 85°C	TSSOP – PW	Tube of 50	TRS3238EIPW	- RS38EI	
-40°C 10 85°C	1330P - PW	Reel of 2000	TRS3238EIPWR	ROJOEI	
	SOIC – DW	Reel of 2000	TRS3238ICDWR	TRS3238EI	
	QFN – RHB	Reel of 2000	TRS3238EIRHBR	PREVIEW	

#### **ORDERING INFORMATION**

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

(2) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI website at www.ti.com.

## TRS3238E 3-V TO 5.5-V MULTICHANNEL RS-232 LINE DRIVER/RECEIVER WITH $\pm 15\text{-kV}$ ESD (HBM) PROTECTION

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#### **FUNCTION TABLES**

#### Each Driver<sup>(1)</sup>

		INPUTS			
DIN	FORCEON	FORCEOFF	TIME ELAPSED SINCE LAST RIN OR DIN TRANSITION	OUTPUT DOUT	DRIVER STATUS
Х	Х	L	X	Z	Powered off
L	Н	Н	X	Н	Normal operation with
н	Н	Н	x	L	auto-powerdown plus disabled
L	L	Н	<30 s	Н	Normal operation with
Н	L	н	<30 s	L	auto-powerdown plus enabled
L	L	Н	>30 s	Z	Powered off by
н	L	Н	>30 s	Z	auto-powerdown plus feature

(1) H = high level, L = low level, X = irrelevant, Z = high impedance

#### Each Receiver<sup>(1)</sup>

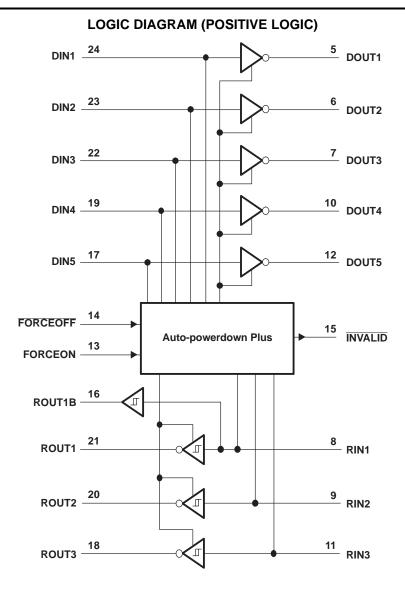
INPUTS				OUT	PUTS	
RIN1 RIN2-RIN3 FORCEOFF		FORCEOFF	TIME ELAPSED SINCE LAST RIN OR DIN TRANSITION	ROUT1B	ROUT2 AND ROUT3	RECEIVER STATUS
L	Х	L	Х	L	Z	Powered off while
Н	Х	L	х	Н	Z	ROUT1B is active
L	L	Н	<30 s	L	Н	
L	Н	Н	<30 s	L	L	Normal operation with
н	L	Н	<30 s	Н	н	auto-powerdown plus
н	н н н		<30 s	Н	L	disabled/enabled
Open	Open	Н	<30 s	L	н	

(1) H = high level, L = low level, X = irrelevant, Z = high impedance (off), Open = input disconnected or connected driver off

# TRS3238E 3-V TO 5.5-V MULTICHANNEL RS-232 LINE DRIVER/RECEIVER WITH $\pm$ 15-kV ESD (HBM) PROTECTION

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#### SLLS797-JUNE 2007

#### Absolute Maximum Ratings<sup>(1)</sup>

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
V <sub>CC</sub>	Supply voltage range <sup>(2)</sup>	-0.3	6	V	
V+	Positive-output supply voltage range <sup>(2)</sup>	Positive-output supply voltage range <sup>(2)</sup>			V
V–	Negative-output supply voltage range <sup>(2)</sup>		0.3	-7	V
V + - V -	Supply voltage difference <sup>(2)</sup>			13	V
VI	Input voltage range	Driver (FORCEOFF, FORCEON)	-0.3	6	V
		Receiver	-25	25	v
	Output voltage range	Driver	-13.2	13.2	V
Vo		Receiver (INVALID)	-0.3	V <sub>CC</sub> + 0.3	v
		DB package		62	
٥	Package thermal impedance <sup>(3)(4)</sup>	DW package		46	°C/W
$\theta_{JA}$	Package inernial impedance (7,7)	PW package		62	-C/W
		RHB package		PREVIEW	
TJ	Operating virtual junction temperature			150	°C
T <sub>stg</sub>	Storage temperature range		-65	150	°C

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) All voltages are with respect to network GND.

(3) Maximum power dissipation is a function of  $T_J(max)$ ,  $\theta_{JA}$ , and  $T_A$ . The maximum allowable power dissipation at any allowable ambient temperature is  $P_D = (T_J(max) - T_A)/\theta_{JA}$ . Operating at the absolute maximum  $T_J$  of 150°C can affect reliability.

(4) The package thermal impedance is calculated in accordance with JESD 51-7.

#### **Recommended Operating Conditions**<sup>(1)</sup>

See Figure 6

				MIN	NOM	MAX	UNIT
	Supply voltage		$V_{CC} = 3.3 V$	3	3.3	3.6	V
Supply voltage			$V_{CC} = 5 V$	4.5	5	5.5	v
V	V Driver and control high layed input voltage	DIN, FORCEOFF,	$V_{CC} = 3.3 V$	2		5.5	V
VIH	Driver and control high-level input voltage	FORCEON	$V_{CC} = 5 V$	2.4		5.5	V
VIL	V <sub>IL</sub> Driver and control low-level input voltage DIN, FORCEOFF, FORCEO			0		0.8	V
VI	VI Receiver input voltage			-25		25	V
т	Operating free air temperature		TRS3238EC	0		70	°C
T <sub>A</sub>	Operating free-air temperature	TRS3238EI	-40		85		

(1) Testing supply conditions are C1–C4 = 0.1  $\mu$ F at V<sub>CC</sub> = 3.3 V ± 0.15 V; C1–C4 = 0.22  $\mu$ F at V<sub>CC</sub> = 3.3 V ± 0.3 V; and C1 = 0.047  $\mu$ F and C2–C4 = 0.33  $\mu$ F at V<sub>CC</sub> = 5 V ± 0.5 V.

#### Electrical Characteristics<sup>(1)</sup>

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 6)

	PARA	METER	TEST CONDITIONS	MIN	TYP <sup>(2)</sup>	MAX	UNIT
I <sub>I</sub>	Input leakage current	FORCEOFF, FORCEON			±0.01	±1	μA
I <sub>CC</sub>		Auto-powerdown plus disabled	No load, FORCEOFF and FORCEON at $V_{CC}$		0.5	2	mA
	Supply current	Powered off	No load, FORCEOFF at GND		1	10	
	(T <sub>A</sub> = 25°C)	Auto-powerdown plus enabled	No load, FORCEOFF at V <sub>CC</sub> , FORCEON at GND, All RIN are open or grounded		1	10	μA

(1) Testing supply conditions are C1–C4 = 0.1  $\mu$ F at V<sub>CC</sub> = 3.3 V ± 0.15 V; C1–C4 = 0.22  $\mu$ F at V<sub>CC</sub> = 3.3 V ± 0.3 V; and C1 = 0.047  $\mu$ F and C2–C4 = 0.33  $\mu$ F at V<sub>CC</sub> = 5 V ± 0.5 V.

(2) All typical values are at  $V_{CC} = 3.3$  V or  $V_{CC} = 5$  V, and  $T_A = 25^{\circ}$ C.

### **TRS3238E** 3-V TO 5.5-V MULTICHANNEL RS-232 LINE DRIVER/RECEIVER WITH ±15-kV ESD (HBM) PROTECTION



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#### **DRIVER SECTION**

#### Electrical Characteristics<sup>(1)</sup>

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 6)

	PARAMETER	TE	ST CONDITIONS	6	MIN	TYP <sup>(2)</sup>	MAX	UNIT
V <sub>OH</sub>	High-level output voltage	All DOUT at $R_L = 3 \ k\Omega$ to	All DOUT at $R_L = 3 \text{ k}\Omega$ to GND			5.4		V
$V_{OL}$	Low-level output voltage	All DOUT at $R_L = 3 k\Omega$ to GND			-5	-5.4		V
I <sub>IH</sub>	High-level input current	$V_I = V_{CC}$				±0.01	±1	μA
$I_{IL}$	Low-level input current	V <sub>I</sub> at GND				±0.01	±1	μA
	Chart aircuit autnut aurrant <sup>(3)</sup>	V <sub>CC</sub> = 3.6 V,	$V_{O} = 0 V$			±35	±60	
I <sub>OS</sub>	Short-circuit output current <sup>(3)</sup>	V <sub>CC</sub> = 5.5 V,	$V_{O} = 0 V$			±40	±100	mA
r <sub>o</sub>	Output resistance	$V_{CC}$ , V+, and V- = 0 V,	$V_0 = \pm 2 V$		300	10M		Ω
			$V_0 = \pm 12 V$ ,	$V_{CC}$ = 3 V to 3.6 V			±25	
I <sub>OZ</sub>	Output leakage current FORCEOFF = GND		$V_{O} = \pm 10 V$ ,	$V_{CC}$ = 4.5 V to 5.5 V			±25	μA

(1) Testing supply conditions are C1–C4 = 0.1  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.15 V; C1–C4 = 0.22  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.3 V; and C1 = 0.047  $\mu$ F and C2–C4 = 0.33  $\mu$ F at V<sub>CC</sub> = 5 V ± 0.5 V.

All typical values are at V<sub>CC</sub> = 3.3 V or V<sub>CC</sub> = 5 V, and T<sub>A</sub> = 25°C. (2)

(3) Short-circuit durations should be controlled to prevent exceeding the device absolute power dissipation ratings, and not more than one output should be shorted at a time.

#### Switching Characteristics<sup>(1)</sup>

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 6)

	PARAMETER	TEST CONDITIONS			TYP <sup>(2)</sup>	MAX	UNIT
Maximum data rate		C <sub>L</sub> = 1000 pF, One DOUT switching,	$R_L = 3 k\Omega$ , See Figure 1	250	400		kbit/s
t <sub>sk(p)</sub>	Pulse skew <sup>(3)</sup>	$C_L = 150 \text{ pF}$ to 2500 pF, See Figure 2	$R_L = 3 k\Omega$ to 7 k $\Omega$ ,		100		ns
SD(tr)	Slew rate, transition region	V <sub>CC</sub> = 3.3 V,	$C_{L} = 150 \text{ pF} \text{ to } 1000 \text{ pF}$	6		30	V/µs
SR(tr)	(see Figure 1)	$R_L = 3 k\Omega$ to 7 k $\Omega$	$C_{L} = 150 \text{ pF} \text{ to } 2500 \text{ pF}$	4		30	v/µs

(1) Testing supply conditions are C1–C4 = 0.1  $\mu$ F at V<sub>CC</sub> = 3.3 V ± 0.15 V; C1–C4 = 0.22  $\mu$ F at V<sub>CC</sub> = 3.3 V ± 0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V ± 0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V ± 0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V ± 0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V ± 0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V ± 0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V ± 0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V ± 0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V ± 0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V ± 0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V ± 0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V ± 0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V ± 0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V ± 0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V ± 0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V ± 0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V ± 0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V ± 0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V ± 0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V ± 0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V ± 0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V ± 0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V ± 0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V ± 0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V ± 0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V ± 0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V ± 0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V ± 0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V ± 0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V ± 0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V ± 0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V ± 0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V ± 0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V ± 0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V ± 0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V ± 0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V ± 0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V ± 0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V ± 0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V ± 0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V ± 0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V \pm 0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V \pm 0. and C2–C4 = 0.33  $\mu$ F at V<sub>CC</sub> = 5 V ± 0.5 V. All typical values are at V<sub>CC</sub> = 3.3 V or V<sub>CC</sub> = 5 V, and T<sub>A</sub> = 25°C.

(2)

(3) Pulse skew is defined as |t<sub>PLH</sub> - t<sub>PHL</sub>| of each channel of the same device.

#### **ESD** Protection

PARAMETER	TEST CONDITIONS	ТҮР	UNIT
	НВМ	±15	
DOUT	IEC 61000-4-2, Air-Gap Discharge	±15	kV
	IEC 61000-4-2, Contact Discharge	±8	

#### **RECEIVER SECTION**

#### Electrical Characteristics<sup>(1)</sup>

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 6)

	PARAMETER	TEST CONDITIONS	MIN	TYP <sup>(2)</sup>	MAX	UNIT
V <sub>OH</sub>	High-level output voltage	I <sub>OH</sub> = -1 mA	V <sub>CC</sub> – 0.6	V <sub>CC</sub> – 0.1		V
V <sub>OL</sub>	Low-level output voltage	I <sub>OL</sub> = 1.6 mA			0.4	V
V	Desitive going input threshold voltage	$V_{CC} = 3.3 V$		1.5	2.4	V
V <sub>IT+</sub> Positive-go	Positive-going input threshold voltage	$V_{CC} = 5 V$		1.8	2.4	v
V	Negative going input threshold voltage	V <sub>CC</sub> = 3.3 V	0.6	1.2		V
V <sub>IT</sub>	Negative-going input threshold voltage	$V_{CC} = 5 V$	0.8	1.5		v
V <sub>hys</sub>	Input hysteresis (V <sub>IT+</sub> – V <sub>IT–</sub> )			0.3		V
I <sub>OZ</sub>	Output leakage current (except ROUT1B)	FORCEOFF = 0 V		±0.05	±10	μA
r <sub>i</sub>	Input resistance	$V_{I} = \pm 3 \text{ V to } \pm 25 \text{ V}$	3	5	7	kΩ

(1) Testing supply conditions are C1–C4 = 0.1  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.15 V; C1–C4 = 0.22  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.15 V; C1–C4 = 0.22  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.15 V; C1–C4 = 0.22  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.15 V; C1–C4 = 0.22  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.15 V; C1–C4 = 0.22  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.15 V; C1–C4 = 0.22  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.15 V; C1–C4 = 0.22  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.15 V; C1–C4 = 0.22  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.15 V; C1–C4 = 0.22  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.15 V; C1–C4 = 0.22  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.15 V; C1–C4 = 0.22  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.15 V; C1–C4 = 0.22  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.15 V; C1–C4 = 0.22  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.15 V; C1–C4 = 0.22  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.15 V; C1–C4 = 0.22  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.15 V; C1–C4 = 0.22  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.15 V; C1–C4 = 0.22  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.15 V; C1–C4 = 0.22  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.15 V; C1–C4 = 0.22  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.15 V; C1–C4 = 0.22  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.15 V; C1–C4 = 0.22  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.15 V; C1–C4 = 0.22  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.15 V; C1–C4 = 0.22  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.15 V; C1–C4 = 0.22  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.15 V; C1–C4 = 0.22  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.15 V; C1–C4 = 0.22  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.15 V; C1–C4 = 0.22  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.15 V; C1–C4 = 0.22  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.15 V; C1–C4 = 0.22  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.15 V; C1–C4 = 0.22  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.15 V; C1–C4 = 0.22  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.15 V; C1–C4 = 0.22  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.15 V; C1–C4 = 0.22  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.15 V; C1–C4 = 0.22  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.15 V; C1–C4 = 0.22  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.15 V; C1–C4 = 0.22  $\mu$ F at V<sub>CC</sub> = 3.3 and C2–C4 = 0.33  $\mu$ F at V<sub>CC</sub> = 5 V ± 0.5 V. All typical values are at V<sub>CC</sub> = 3.3 V or V<sub>CC</sub> = 5 V, and T<sub>A</sub> = 25°C.

(2)

#### Switching Characteristics<sup>(1)</sup>

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	TYP <sup>(2)</sup>	UNIT
t <sub>PLH</sub>	Propagation delay time, low- to high-level output	C <sub>L</sub> = 150 pF, See Figure 3	150	ns
t <sub>PHL</sub>	Propagation delay time, high- to low-level output	C <sub>L</sub> = 150 pF, See Figure 3	150	ns
t <sub>en</sub>	Output enable time	$C_L = 150 \text{ pF}, R_L = 3 \text{ k}\Omega$ , See Figure 4	200	ns
t <sub>dis</sub>	Output disable time	$C_L = 150 \text{ pF}, R_L = 3 \text{ k}\Omega$ , See Figure 4	200	ns
t <sub>sk(p)</sub>	Pulse skew <sup>(3)</sup>	See Figure 3	50	ns

Testing supply conditions are C1–C4 = 0.1  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.15 V; C1–C4 = 0.22  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.3 V; and C1 = 0.047  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.3 V; an (1) and C2–C4 = 0.33  $\mu$ F at V<sub>CC</sub> = 5 V ± 0.5 V.

(2) All typical values are at  $V_{CC} = 3.3$  V or  $V_{CC} = 5$  V, and  $T_A = 25^{\circ}C$ . (3) Pulse skew is defined as  $|t_{PLH} - t_{PHL}|$  of each channel of the same device.

#### **ESD** Protection

PARAMETER	TEST CONDITIONS	TYP	UNIT
	НВМ	±15	
RIN	IEC 61000-4-2, Air-Gap Discharge	±15	kV
	IEC 61000-4-2, Contact Discharge	±8	

## TRS3238E 3-V TO 5.5-V MULTICHANNEL RS-232 LINE DRIVER/RECEIVER WITH $\pm 15\text{-kV}$ ESD (HBM) PROTECTION



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#### AUTO-POWERDOWN PLUS SECTION

#### **Electrical Characteristics**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 5)

	PARAMETER	TEST CONDITIONS	MIN	MAX	UNIT
V <sub>T+(valid)</sub>	Receiver input threshold for INVALID high-level output voltage	FORCEON = GND, $\overline{\text{FORCEOFF}} = V_{CC}$		2.7	V
V <sub>T-(valid)</sub>	Receiver input threshold for INVALID high-level output voltage	FORCEON = GND, $\overline{\text{FORCEOFF}} = V_{CC}$	-2.7		V
V <sub>T(invalid)</sub>	Receiver input threshold for INVALID low-level output voltage	FORCEON = GND, $\overline{\text{FORCEOFF}} = V_{CC}$	-0.3	0.3	V
V <sub>OH</sub>	INVALID high-level output voltage	$I_{OH} = -1$ mA, FORCEON = GND, FORCEOFF = V <sub>CC</sub>	$V_{CC} - 0.6$		V
V <sub>OL</sub>	INVALID low-level output voltage	$I_{OL}$ = 1.6 mA, FORCEON = GND, FORCEOFF = V <sub>CC</sub>		0.4	V

#### **Switching Characteristics**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 5)

	PARAMETER	MIN	TYP <sup>(1)</sup>	MAX	UNIT
t <sub>valid</sub>	Propagation delay time, low- to high-level output		0.1		μs
t <sub>invalid</sub>	Propagation delay time, high- to low-level output		50		μs
t <sub>en</sub>	Supply enable time		25		μs
t <sub>dis</sub>	Receiver or driver edge to auto-powerdown plus	15	30	60	s

(1) All typical values are at V\_{CC} = 3.3 V or V\_{CC} = 5 V, and T\_A = 25 ^{\circ}C.

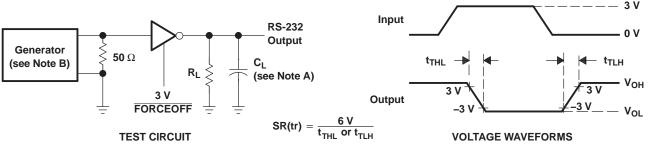
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#### TRS3238E 3-V TO 5.5-V MULTICHANNEL RS-232 LINE DRIVER/RECEIVER WITH ±15-kV ESD (HBM) PROTECTION

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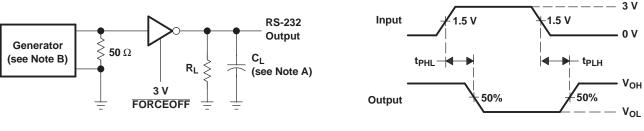
#### PARAMETER MEASUREMENT INFORMATION



- A. C<sub>L</sub> includes probe and jig capacitance.

В. The pulse generator has the following characteristics: PRR = 250 kbit/s,  $Z_0$  = 50  $\Omega$ , 50% duty cycle,  $t_r \leq$  10 ns,  $t_f \leq 10$  ns.

#### Figure 1. Driver Slew Rate

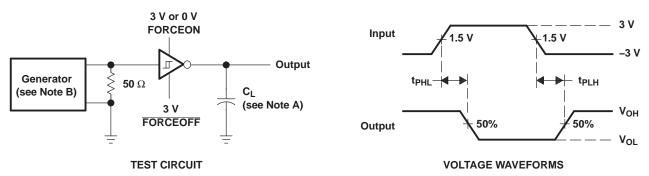


**TEST CIRCUIT** 

**VOLTAGE WAVEFORMS** 

- C<sub>L</sub> includes probe and jig capacitance. Α.
- The pulse generator has the following characteristics: PRR = 250 kbit/s, Z\_0 = 50  $\Omega$ , 50% duty cycle, t<sub>r</sub>  $\leq$  10 ns, Β.  $t_f \leq 10 \text{ ns.}$

#### Figure 2. Driver Pulse Skew



- C<sub>1</sub> includes probe and jig capacitance. Α.
- The pulse generator has the following characteristics: Z\_O = 50  $\Omega$ , 50% duty cycle,  $t_r~\leq$  10 ns,  $t_f~\leq$  10 ns. В.

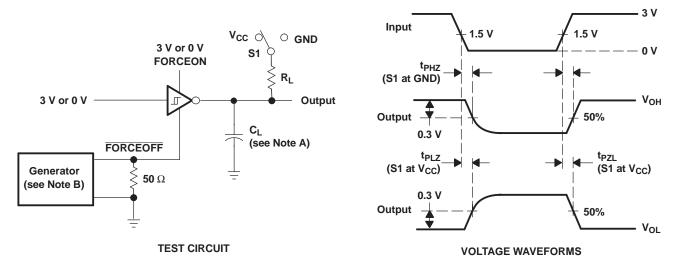
#### Figure 3. Receiver Propagation Delay Times

## TRS3238E 3-V TO 5.5-V MULTICHANNEL RS-232 LINE DRIVER/RECEIVER WITH $\pm$ 15-kV ESD (HBM) PROTECTION



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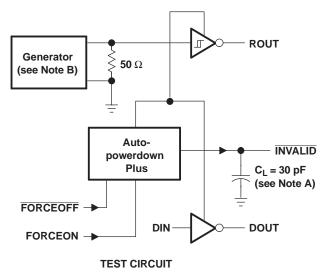
- A.  $C_L$  includes probe and jig capacitance.
- B. The pulse generator has the following characteristics:  $Z_0 = 50 \ \Omega$ , 50% duty cycle,  $t_r \le 10 \text{ ns}$ ,  $t_f \le 10 \text{ ns}$ .
- C.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
- D.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .

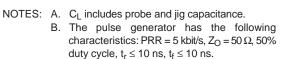
#### Figure 4. Receiver Enable and Disable Times

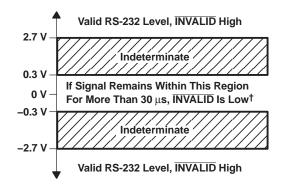
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#### PARAMETER MEASUREMENT INFORMATION (continued)







 $^\dagger$  Auto-powerdown plus disables drivers and reduces supply current to 1  $\mu A.$ 

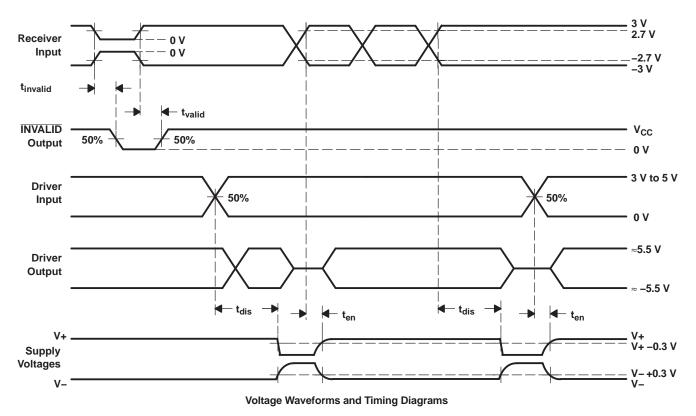


Figure 5. INVALID Propagation-Delay Times and Supply-Enabling Time

## TRS3238E 3-V TO 5.5-V MULTICHANNEL RS-232 LINE DRIVER/RECEIVER WITH $\pm$ 15-kV ESD (HBM) PROTECTION

SLLS797-JUNE 2007

#### **APPLICATION INFORMATION**

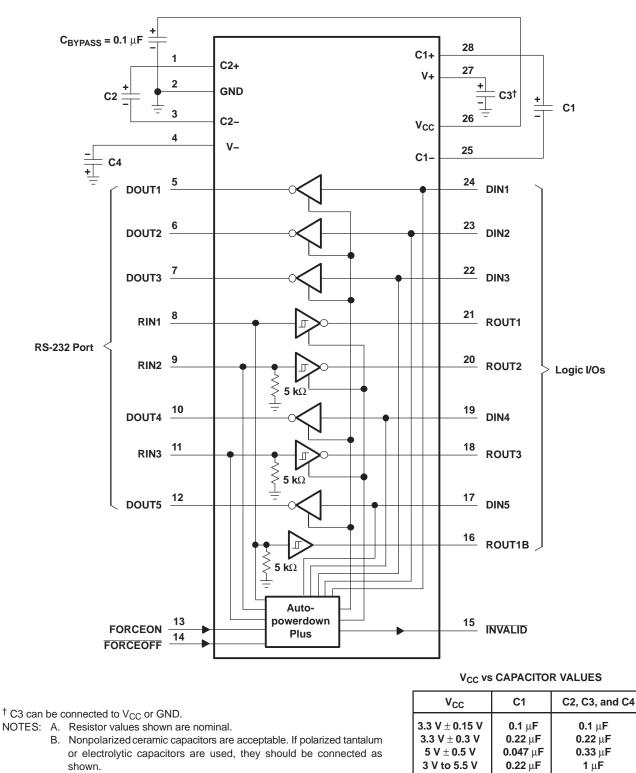


Figure 6. Typical Operating Circuit and Capacitor Values



#### PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
							(6)				
TRS3238ECDB	OBSOLETE	SSOP	DB	28		TBD	Call TI	Call TI	0 to 70	TRS3238EC	
TRS3238EIDB	OBSOLETE	SSOP	DB	28		TBD	Call TI	Call TI	-40 to 85	TRS3238EI	
TRS3238EIPWR	ACTIVE	TSSOP	PW	28	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	RS38EI	Samples

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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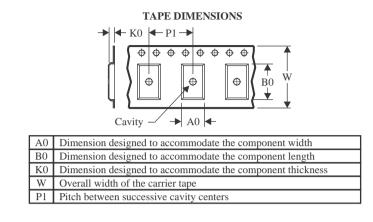
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## PACKAGE MATERIALS INFORMATION

20-Apr-2024

#### TAPE AND REEL INFORMATION





#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal	
All ultrensions are norminal	

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TRS3238EIPWR	TSSOP	PW	28	2000	330.0	16.4	6.9	10.2	1.8	12.0	16.0	Q1



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## PACKAGE MATERIALS INFORMATION

20-Apr-2024



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TRS3238EIPWR	TSSOP	PW	28	2000	356.0	356.0	35.0

## **DB0028A**

## **PACKAGE OUTLINE**



SMALL OUTLINE PACKAGE



NOTES:

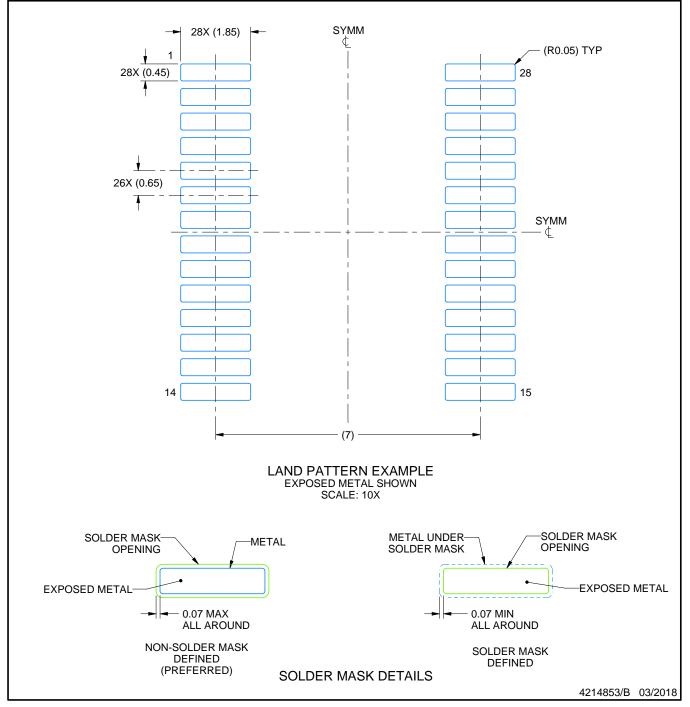
- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M. 2. This drawing is subject to change without notice. 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
- 5. Reference JEDEC registration MO-150.



## **EXAMPLE BOARD LAYOUT**

### SSOP - 2 mm max height

SMALL OUTLINE PACKAGE



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

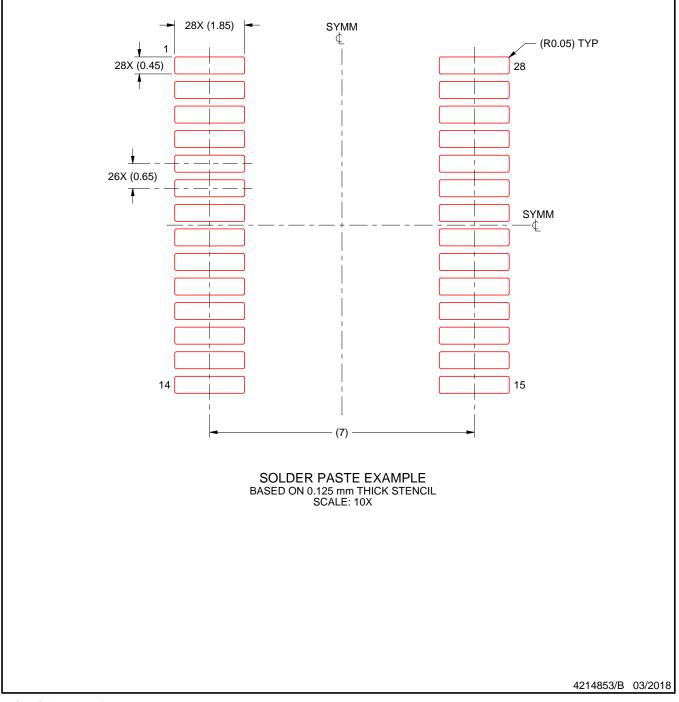


## DB0028A

## **EXAMPLE STENCIL DESIGN**

### SSOP - 2 mm max height

SMALL OUTLINE PACKAGE



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.

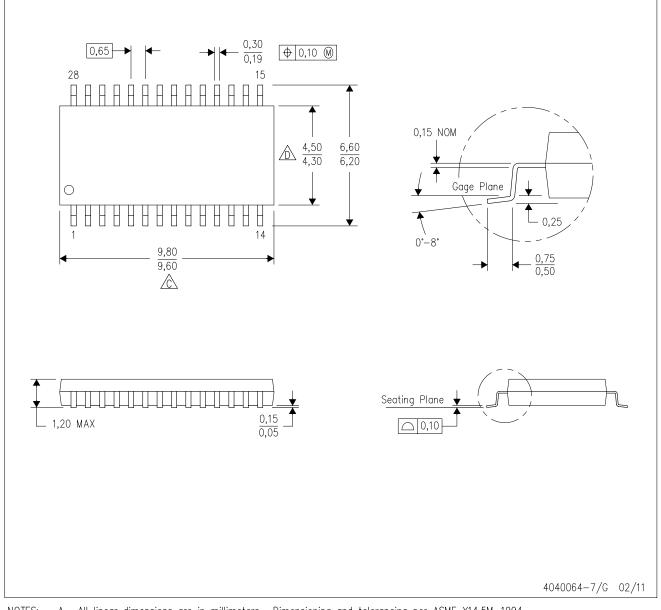


### DB0028A

### **MECHANICAL DATA**

PW (R-PDSO-G28)

PLASTIC SMALL OUTLINE



NOTES:

A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
B. This drawing is subject to change without notice.

Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0,15 each side.

Body width does not include interlead flash. Interlead flash shall not exceed 0,25 each side.

E. Falls within JEDEC MO-153



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